

DMP2123L P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Features

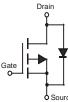
- Low R_{DS(ON)}:
 - 72 mΩ @V_{GS} = -4.5V
 - 108 mΩ @V_{GS} = -2.7V
 - 123 mΩ @V_{GS} = -2.5V
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- "Green" Device (Note 4)

Mechanical Data

- Case: SOT-23
- Case Material Molded Plastic, "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram Below
- Marking Information: See Page 4
- Ordering Information: See page 4
 - Weight: 0.008 grams (approximate)







Internal Schematic



TOP VIEW

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-20	V	
Gate-Source Voltage		V _{GSS}	±12	V	
Drain Current (Note 1) Continuous	T _A = 25°C T _A = 70°C	ID	-3.0 -2.4	А	
Pulsed Drain Current (Note 2)		I _{DM}	-15	A	
Body-Diode Continuous Current (Note 1)		I _S	2.0	A	

Thermal Characteristics

Notes:

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 1); Steady-State	$R_{ extsf{ heta}JA}$	90	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

1. Device mounted on 1"x1", FR-4 PC board with 2 oz. Copper and test pulse width t ≤10s.

2. Repetitive Rating, pulse width limited by junction temperature.

3. No purposefully added lead.

4. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

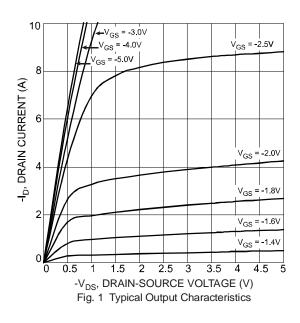


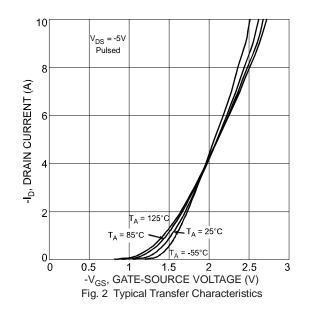
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
STATIC PARAMETERS				•		
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_		V	$I_D = -250 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current $T_J = 25^{\circ}C$	I _{DSS}	_	_	-1	μA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Body Leakage Current	I _{GSS}	_	_	±100	nA	$V_{DS} = 0V, V_{GS} = \pm 12V$
Gate Threshold Voltage	V _{GS(th)}	-0.6		-1.25	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
On State Drain Current (Note 5)	I _{D (ON)}	-15		_	А	$V_{GS} = -4.5V, V_{DS} = -5V$
			51	72		V _{GS} = -4.5V, I _D = -3.5A
Static Drain-Source On-Resistance (Note 5)	R _{DS} (ON)	—	87	108	mΩ	$V_{GS} = -2.7V, I_D = -3.0A$
			99	123		$V_{GS} = -2.5V, I_D = -2.6A$
Forward Transconductance (Note 5)	g fs	_	7.3		S	$V_{DS} = -10V, I_D = -3.0A$
Diode Forward Voltage (Note 5)	V _{SD}	_	0.79	-1.26	V	$I_{S} = -1.7A, V_{GS} = 0V$
Maximum Body-Diode Continuous Current (Note 1)	Is	—	_	1.7	А	_
DYNAMIC PARAMETERS (Note 6)						
Total Gate Charge	Qg	_	7.3	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V, I_D = -3.0A$
Gate-Source Charge	Qgs	_	2.0	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V, I_D = -3.0A$
Gate-Drain Charge	Q _{gd}	_	1.9		nC	V _{GS} = -4.5V, V _{DS} = -10V, I _D = -3.0A
Turn-On Delay Time	t _{D(on)}	_	12	_	ns	
Turn-On Rise Time	tr	_	20	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(off)}	_	38		ns	$R_L = 10\Omega, R_G = 6\Omega$
Turn-Off Fall Time	t _f	_	41		ns]
Input Capacitance	Ciss		443		pF	
Output Capacitance	Coss		128		pF	V _{DS} = -16V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	101		pF	

Notes: 5. Test pulse width $t = 300 \mu s$.

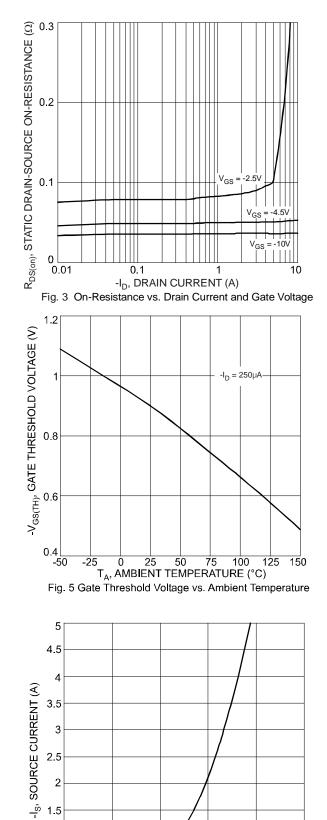
6. Guaranteed by design. Not subject to production testing.

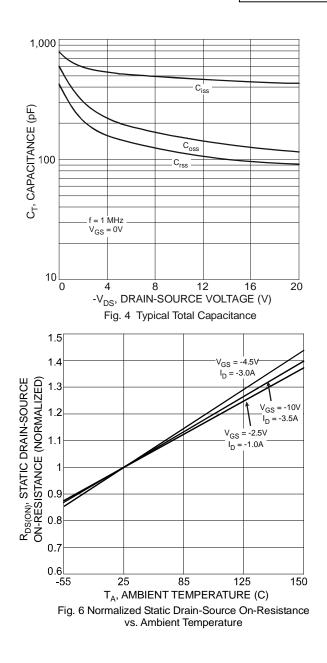






NEW PRODUCT





0.6

0.7

0.8

-V_{SD}, SOURCE DRAIN VOLTAGE (V) Fig. 7 Reverse Drain Current vs. Source-Drain Voltage

0.9

1

1

0.5∟ 0.5



Ordering Information (Note 7)

Part Number	Case	Packaging
DMP2123L-7	SOT-23	3000/Tape & Reel

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

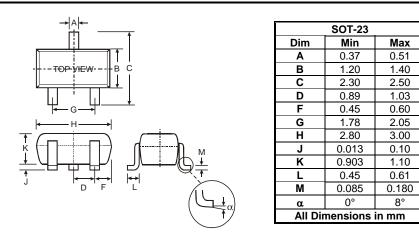


 $\begin{array}{l} M1P = Product Type Marking Code \\ YM = Date Code Marking \\ Y = Year ex: U = 2007 \\ M = Month ex: 9 = September \end{array}$

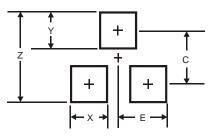
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Date Code Key												
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Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Package Outline Dimensions



Suggested Pad Layout



Value (in mm)
2.9
0.8
0.9
2.0
1.35

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